



SBR12E45LH1

12A SBR SUPER BARRIER RECTIFIER **POWERDI**

Product Summary

V _{RRM} (V)	I _O (A)	V _{F(TYP)} @ +125°C (V)	I _{R(MAX)} @ V _{RRM} (mA)
45	12	0.40	0.3

Description

The SBR12E45LH1 uses SBR patented technology that offers ultralow V_F to reduce forward power loss and improve efficiency. Encapsulated in the new PowerDI5SP (Type B) package with a 0.75mm low height profile and protruding leads for easy soldering, it is especially suited for use as a bypass diode in solar panels.

Applications

Solar Bypass Diode

PowerDI5SP (Type B)



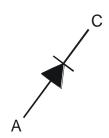
Top View

Features

- Designed as bypass diodes for solar panels
- Low profile height (0.75mm) and 7.6mm protruding leads, enabling the package to be integrated within the solar glass panel
- Selectively rated for +200°C maximum junction temperature for high thermal reliability and excellent high temperature stability
- Patented Super Barrier Rectifier SBR® technology
- Ultra low forward voltage drop to minimize forward power losses
- Very low reverse leakage to ensures maximum efficiency of solar
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: PowerDI5SP (Type B)
- Case Material: Molded Plastic, UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead-Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208 @3
- Polarity: Cathode Bar Mark on Top and Cathode Notch on Lead
- Weight: 0.199 grams (Approximate)



Pin Configuration

Ordering Information (Note 4)

Part Number	Case	Packaging
SBR12E45LH1-13	PowerDI5SP (Type B)	3000 / Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html. Device is packed with marking code side down to the pocket of 32mm carrier tape and carrier tape is wound with device facing inside of reel.

Marking Information



12E45LH1 = Product Type Marking Code Dil = Manufacturers' Code Marking YYWWK = Date Code Marking YY = Last Two Digits of Year (ex: 16 for 2016) WW = Week Code (01 to 53) K = Factory Designator



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _{RM}	45	V
Average Rectified Output Current	lo	12	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	300	А

Thermal Characteristics

Characteristic		Symbol	Value	Unit	
Typical Thermal Resistance Junction to Ambient (Note 5)		$R_{ heta JA}$	66	°C/W	
Operating Temperature Range	V _R ≤ 80% V _{RRM}	т.	-65 to +150	°C	
Operating Temperature Range	DC Forward Mode (Note 6)	IJ	≤ 200		
Storage Temperature Range		T _{STG}	-55 to +175	°C	

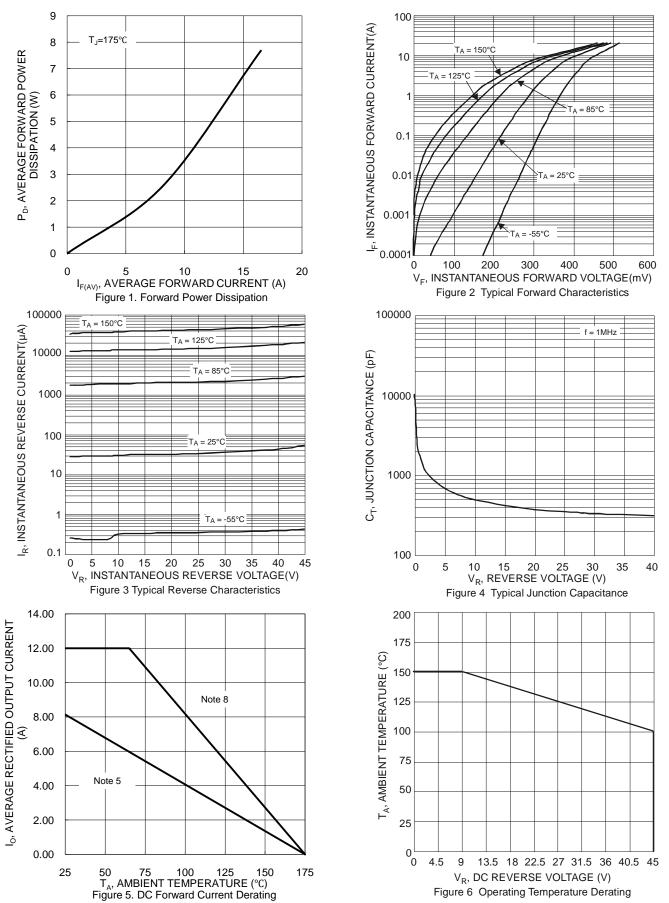
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
		1	0.42	0.50	V	I _F = 10A, T _J = +25°C
Forward Voltage Drop	V_{F}	1	0.44	0.52		I _F = 12A, T _J = +25°C
		_	0.40	0.47		I _F = 12A, T _J = +125°C
	I _R	_	35	200	uА	$V_R = 40V, T_J = +25^{\circ}C$
Lockage Current (Note 7)		_	40	300		$V_R = 45V, T_J = +25^{\circ}C$
Leakage Current (Note 7)		_	15	_	mA	$V_R = 45V, T_J = +125^{\circ}C$
		_	40	_		$V_R = 45V, T_J = +150$ °C

Notes:

- 5. FR-4 PCB, 2oz. Copper, minimum recommended pad layout per http://www.diodes.com/package-outlines.html.
- 6. Max junction temperature +200°C guaranteed for 2 hours at maximum output.
- 7. Short duration pulse test used to minimize self-heating effect.





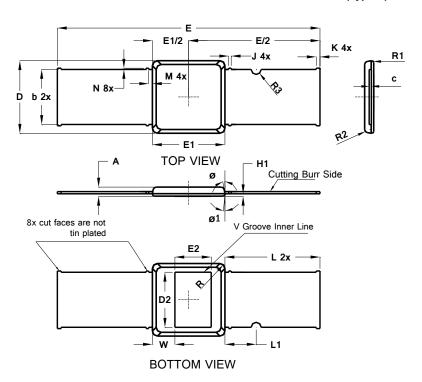
Note: 8. Device mounted on FR-4 substrate PCB with 10cm*10cm double-sided copper pad. SBR and POWERDI are registered trademarks of Diodes Incorporated. SBR12E45LH1 3 of 5



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5SP (Type B)

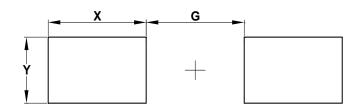


Type B Typ	PowerDI5SP					
A - 0.75 - b 4.30 4.50 4.40 c 0.155 0.191 - D 5.70 5.90 5.80 D2 4.40 - - E 20.8 21.2 21.0 E1 5.70 5.90 5.80 E2 2.90 - - H1 0.19 0.21 0.20 J - - 0.30 L - - 0.30 L - - 0.30 M - - 0.30 N 0 0.20 - R - - 0.40 R1 - - 0.25 R3 - - 0.40 W 1.63 1.97 1.80 Ø 8° 12° -						
A - 0.75 - b 4.30 4.50 4.40 c 0.155 0.191 - D 5.70 5.90 5.80 D2 4.40 - - E 20.8 21.2 21.0 E1 5.70 5.90 5.80 E2 2.90 - - H1 0.19 0.21 0.20 J - - 0.30 L - - 0.30 L - - 0.30 M - - 0.30 N 0 0.20 - R - - 0.40 R1 - - 0.25 R3 - - 0.40 W 1.63 1.97 1.80 Ø 8° 12° -	Dim	Min	Max	Тур		
c 0.155 0.191 − D 5.70 5.90 5.80 D2 4.40 − − E 20.8 21.2 21.0 E1 5.70 5.90 5.80 E2 2.90 − − H1 0.19 0.21 0.20 J − − 0.30 L − − 0.30 L1 − − 0.30 M − − 0.30 N 0 0.20 − R − − 0.40 R1 − − 0.15 R2 − − 0.40 W 1.63 1.97 1.80 Ø 8° 12° −		_	0.75	_		
D 5.70 5.90 5.80 D2 4.40 − − E 20.8 21.2 21.0 E1 5.70 5.90 5.80 E2 2.90 − − H1 0.19 0.21 0.20 K − − 0.30 L − − 7.60 L1 − − 2.50 M − − 0.30 N 0 0.20 − R − − 0.40 R1 − − 0.25 R3 − − 0.40 W 1.63 1.97 1.80 Ø 8° 12° −	b	4.30	4.50	4.40		
D2 4.40 − − E 20.8 21.2 21.0 E1 5.70 5.90 5.80 E2 2.90 − − H1 0.19 0.21 0.20 J − − 0.30 L − − 7.60 L1 − − 2.50 M − − 0.30 N 0 0.20 − R − − 0.40 R1 − − 0.15 R2 − − 0.40 W 1.63 1.97 1.80 Ø 8° 12° −		0.155	0.191	_		
E 20.8 21.2 21.0 E1 5.70 5.90 5.80 E2 2.90 H1 0.19 0.21 0.20 K 0.30 L - 7.60 L1 - 2.50 M - 0.30 N 0 0.20 - R - 0.40 R1 - 0.15 R2 - 0.40 W 1.63 1.97 1.80 Ø 8⁰ 12⁰ -		5.70	5.90	5.80		
E1 5.70 5.90 5.80 E2 2.90 - - H1 0.19 0.21 0.20 K - - 0.30 L - - 7.60 L1 - - 0.30 N 0 0.20 - R - - 0.40 R1 - - 0.25 R3 - - 0.40 W 1.63 1.97 1.80 Ø 8° 12° -		4.40	_	_		
E2 2.90 - - H1 0.19 0.21 0.20 J - - 0.30 L - - 7.60 L1 - - 2.50 M - - 0.30 N 0 0.20 - R - - 0.40 R1 - - 0.25 R3 - - 0.40 W 1.63 1.97 1.80 Ø 8° 12° -		20.8	21.2	21.0		
H1 0.19 0.21 0.20 J - - 0.20 K - - 0.30 L - - 7.60 L1 - - 2.50 M - - 0.30 N 0 0.20 - R - - 0.40 R1 - - 0.15 R2 - - 0.40 W 1.63 1.97 1.80 Ø 8° 12° -	E1	5.70	5.90	5.80		
J - - 0.20 K - - 0.30 L - - 7.60 L1 - - 2.50 M - - 0.30 N 0 0.20 - R - - 0.40 R1 - - 0.25 R3 - - 0.40 W 1.63 1.97 1.80 Ø 8° 12° -	E2	2.90	_	1		
K - - 0.30 L - - 7.60 L1 - - 2.50 M - - 0.30 N 0 0.20 - R - - 0.40 R1 - - 0.15 R2 - - 0.25 R3 - - 0.40 W 1.63 1.97 1.80 Ø 8° 12° -	H1	0.19	0.21	0.20		
L - - 7.60 L1 - - 2.50 M - - 0.30 N 0 0.20 - R - - 0.40 R1 - - 0.15 R2 - - 0.25 R3 - - 0.40 W 1.63 1.97 1.80 Ø 8° 12° -	7	_	_	0.20		
L1 - - 2.50 M - - 0.30 N 0 0.20 - R - - 0.40 R1 - - 0.15 R2 - - 0.25 R3 - - 0.40 W 1.63 1.97 1.80 Ø 8° 12° -	K	-	_	0.30		
M - - 0.30 N 0 0.20 - R - - 0.40 R1 - - 0.15 R2 - - 0.25 R3 - - 0.40 W 1.63 1.97 1.80 Ø 8° 12° -		_	_	7.60		
N 0 0.20 - R - - 0.40 R1 - - 0.15 R2 - - 0.25 R3 - - 0.40 W 1.63 1.97 1.80 Ø 8° 12° -	L1	-	_	2.50		
R - - 0.40 R1 - - 0.15 R2 - - 0.25 R3 - - 0.40 W 1.63 1.97 1.80 Ø 8° 12° -	М	-	_	0.30		
R1 - - 0.15 R2 - - 0.25 R3 - - 0.40 W 1.63 1.97 1.80 Ø 8° 12° -	N	0	0.20	_		
R2 - - 0.25 R3 - - 0.40 W 1.63 1.97 1.80 Ø 8° 12° -	R	_	_	0.40		
R3 - - 0.40 W 1.63 1.97 1.80 Ø 8° 12° -	R1	_	_	0.15		
W 1.63 1.97 1.80 Ø 8° 12° -	R2	-	_	0.25		
W 1.63 1.97 1.80 Ø 8° 12° -	R3	_	_	0.40		
	W		1.97			
64 20 70	Ø	8°	12º	_		
ושן ט"ן "כן ושן –	Ø1	3º	7º	_		
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5SP (Type B)



Dimensions	Value (in mm)		
G	8.101		
Х	8.100		
Y	5.100		



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